

# **IRF9510STRR Datasheet**



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DiGi Electronics Part Number

IRF9510STRR-DG

Manufacturer

Vishay Siliconix

Manufacturer Product Number

IRF9510STRR

Description

MOSFET P-CH 100V 4A D2PAK

**Detailed Description** 

P-Channel 100 V 4A (Tc) 3.7W (Ta), 43W (Tc) Surfac

e Mount TO-263 (D2PAK)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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### **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
IRF9510STRR	Vishay Siliconix
Series:	Product Status:
	Obsolete
FET Type:	Technology:
P-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
100 V	4A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
10V	1.20hm @ 2.4A, 10V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
4V @ 250μA	8.7 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	200 pF @ 25 V
FET Feature:	Power Dissipation (Max):
-	3.7W (Ta), 43W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 175°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
TO-263 (D2PAK)	TO-263-3, D2PAK (2 Leads + Tab), TO-263AB
Base Product Number:	
IRF9510	

## **Environmental & Export classification**

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	



### IRF9510S, SiHF9510S

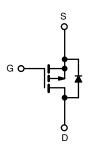
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HALOGEN FREE

### Power MOSFET







P-Channel MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-100				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = -10 V 1.2				
Q <sub>g</sub> max. (nC)	8.7				
Q <sub>gs</sub> (nC)	2.2				
Q <sub>gd</sub> (nC)	4.1				
Configuration	Single				

#### **FEATURES**

- Surface-mount
- Available in tape and reel
- Dynamic dV/dt rating
- · Repetitive avalanche rated
- P-channel
- 175 °C operating temperature
- · Fast switching
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface-mount power package capable of accommodating die size up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface-mount package. The  $D^2PAK$  (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION					
Package	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)			
Lead (Pb)-free and Halogen-free	SiHF9510S-GE3	SiHF9510STRL-GE3 a			
Lead (Pb)-free	IRF9510SPbF	IRF9510STRLPbF <sup>a</sup>			
Lead (PD)-Iree	IRF9510STRRPbF	-			

#### Note

See device orientation

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	-100	V
Gate-Source Voltage			$V_{GS}$	± 20	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Continuous Drain Current	\/ at 10.\/	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	1_	-4.0	
Continuous Drain Current	VGS at -10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	-2.8	Α
Pulsed Drain Current a			I <sub>DM</sub>	-16	
Linear Derating Factor				0.29	W/°C
Linear Derating Factor (PCB mount) e				0.025	7 W/C
Single Pulse Avalanche Energy b			E <sub>AS</sub>	200	mJ
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	-4.0	А
Repetiitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	4.3	mJ
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			P <sub>D</sub>	43	w
Maximum Power Dissipation (PCB mount) e T <sub>A</sub> = 25 °C				3.7	- vv
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	-5.5	V/ns
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C
Soldering Recommendations (Peak temperature) d for 10 s			-	300	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 18 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 4.0 A (see fig. 12) c.  $I_{SD}$  ≤ 4.0 A, dI/dt ≤ 75 A/ $\mu$ s,  $V_{DD}$  ≤  $V_{DS}$ ,  $V_{DS}$  = 175 °C d. 1.6 mm from case

S21-0904-Rev. D, 30-Aug-2021

When mounted on 1" square PCB (FR-4 or G-10 material)

Document Number: 91073



### IRF9510S, SiHF9510S

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THERMAL RESISTANCE RATINGS						
PARAMETER SYMBOL TYP. MAX. UNIT						
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62			
Maximum Junction-to-Ambient (PCB mount) <sup>a</sup>	R <sub>thJA</sub>	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.5			

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$ , $I_D = -250 \mu A$		-100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = -1 mA	-	-0.091	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-2.0	-	-4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zone Cota Valtana Dunia Comment		V <sub>DS</sub> =	V <sub>DS</sub> = -100 V, V <sub>GS</sub> = 0 V		-	- 100	1
Zero Gate Voltage Drain Current	$I_{DSS}$	V <sub>DS</sub> = -80 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -2.4 A <sup>b</sup>	-	-	1.2	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	-50 V, I <sub>D</sub> = -2.4 A <sup>b</sup>	1.0	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	200	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = -25 \text{ V},$	-	94	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	.0 MHz, see fig. 5	-	18	-	
Total Gate Charge	Qg		$V_{GS} = -10 \text{ V}$ $I_D = -4.0 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 b		-	8.7	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = -10 V			-	2.2	
Gate-Drain Charge	Q <sub>gd</sub>	1	See lig. 0 and 15	-	-	4.1	1
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = -50 \text{ V, } I_D = -4.0 \text{ A,}$ $R_g = 24 \ \Omega, \ R_D = 11 \ \Omega, \ \text{see fig. 10} \ ^\text{b}$		-	10	-	- ns
Rise Time	t <sub>r</sub>			-	27	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	15	-	
Fall Time	t <sub>f</sub>			-	17	-	
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		1.5	-	7.9	Ω
Internal Drain Inductance	L <sub>D</sub>	Between lead		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>	6 mm (0.25") from package and center of die contact		-	7.5	-	nH
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET s	, ID	-	-	-4.0	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	showing the integral reverse p -n junction diode		-	-	-16	А
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C,	I <sub>S</sub> = -4.0 A, V <sub>GS</sub> = 0 V b	-	-	-5.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-		-	82	160	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = -4.0  \text{A},  \text{dI/dt} = 100  \text{A/} \mu \text{s}^{ \text{b}}$		-	0.15	0.30	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and			v Ls and	L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

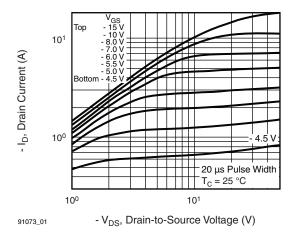


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

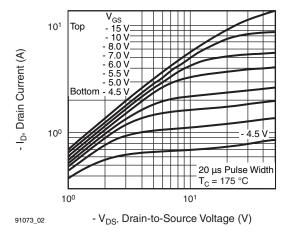


Fig. 2 - Typical Output Characteristics,  $T_C = 175$  °C

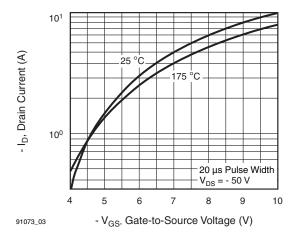


Fig. 3 - Typical Transfer Characteristics

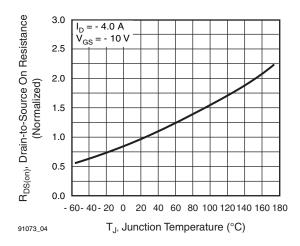


Fig. 4 - Normalized On-Resistance vs. Temperature

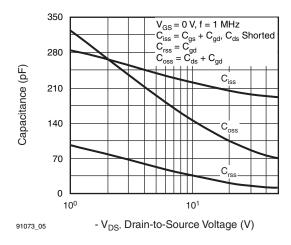


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

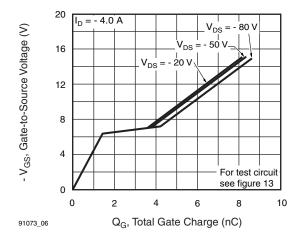


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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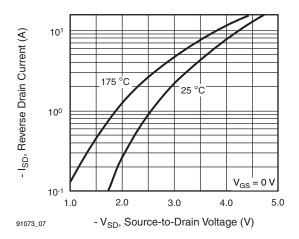


Fig. 7 - Typical Source-Drain Diode Forward Voltage

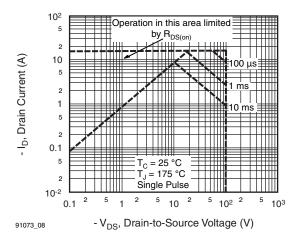


Fig. 8 - Maximum Safe Operating Area

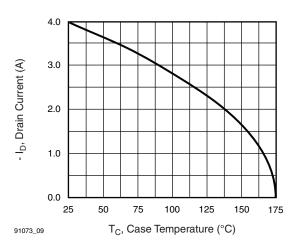


Fig. 9 - Maximum Drain Current vs. Case Temperature

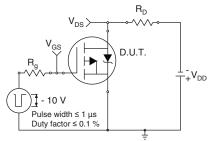


Fig. 10a - Switching Time Test Circuit

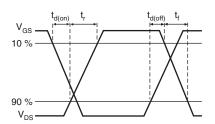


Fig. 10b - Switching Time Waveforms

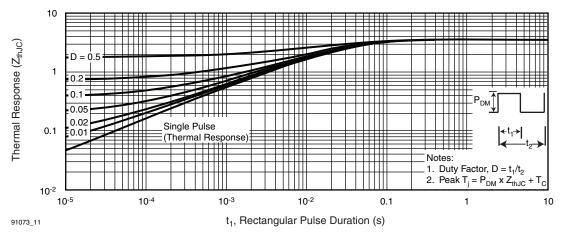


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

### IRF9510S, SiHF9510S

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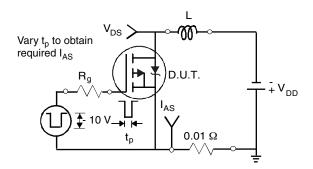


Fig. 12a - Unclamped Inductive Test Circuit

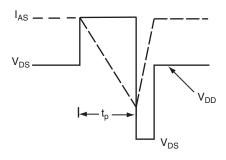


Fig. 12b - Unclamped Inductive Waveforms

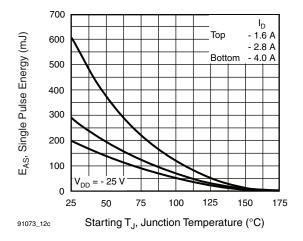


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

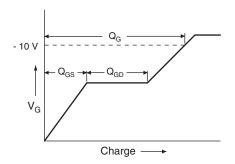


Fig. 13a - Basic Gate Charge Waveform

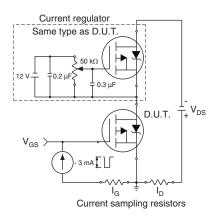


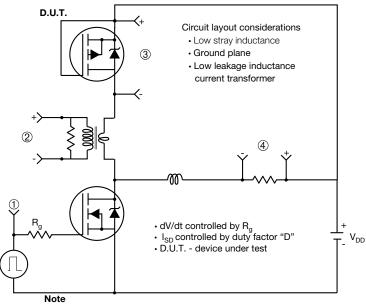
Fig. 13b - Gate Charge Test Circuit

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### **IRF9510S, SiHF9510S**

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#### Peak Diode Recovery dV/dt Test Circuit



· Compliment N-Channel of D.U.T. for driver

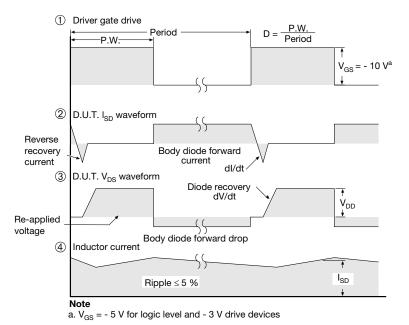


Fig. 14 - For P-Channel

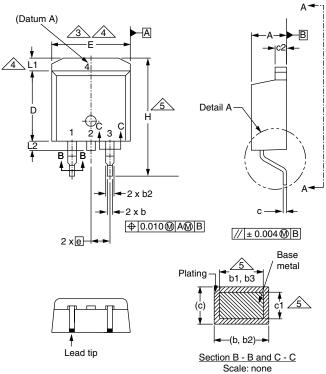
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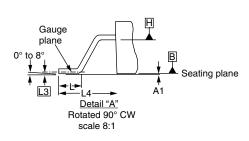


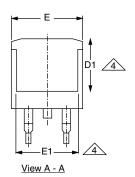
### **Package Information**

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#### **TO-263AB (HIGH VOLTAGE)**







MILLIMETERS			INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
D1	6.86	-	0.270	-	
Е	9.65	10.67	0.380	0.420	
E1	6.22	-	0.245	-	
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	ı	0.066	
L2	-	1.78	-	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

ECN: S-82110-Rev. A, 15-Sep-08

#### DWG: 5970 **Notes**

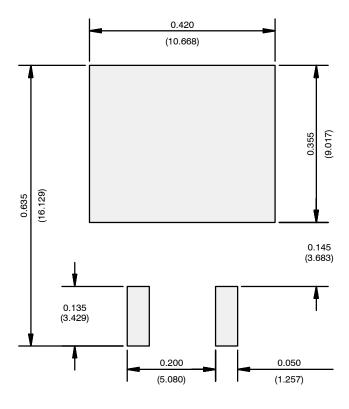
- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 Revision: 15-Sep-08



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### RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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